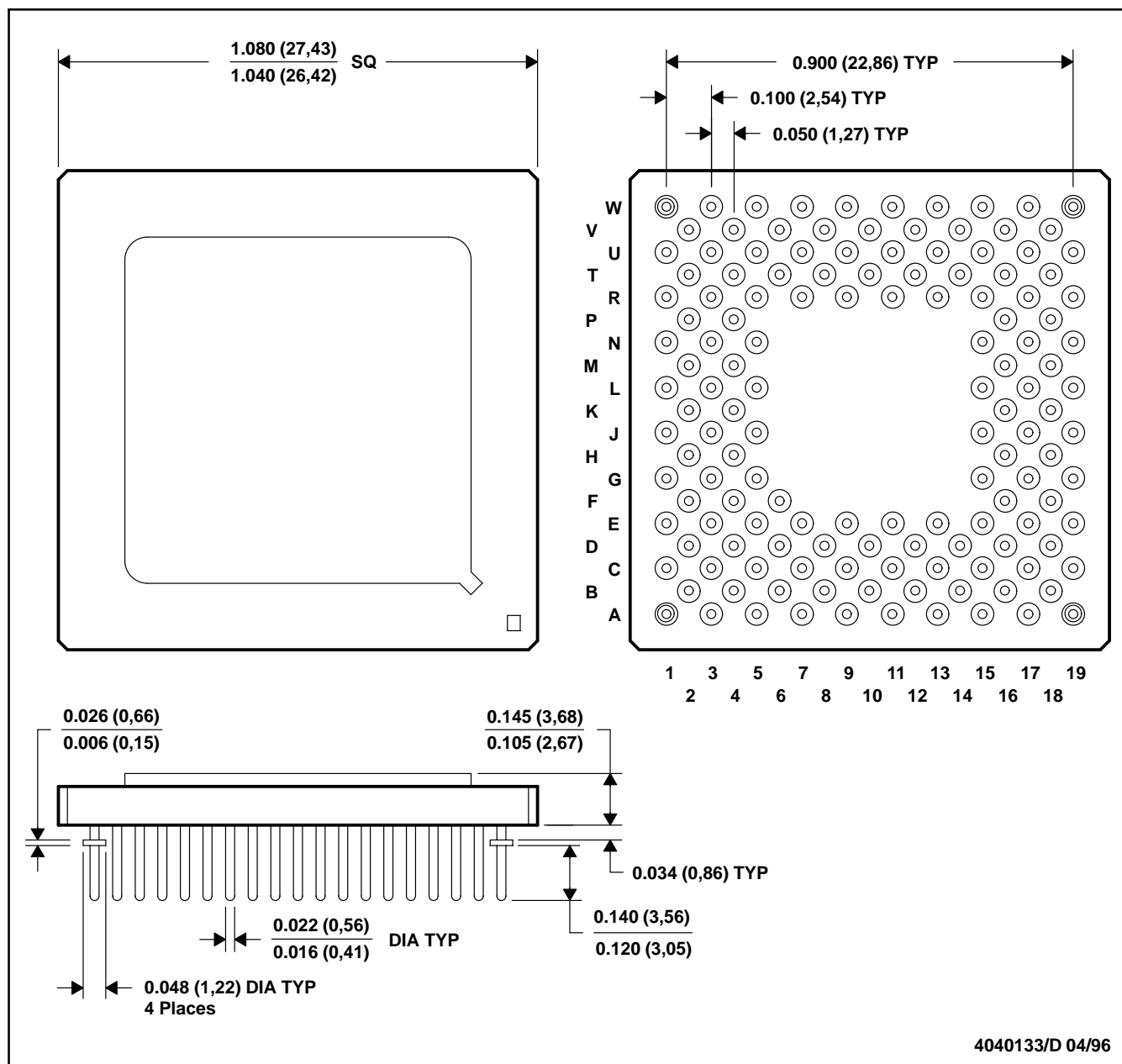


## GFA (S-CPGA-P141)

## CERAMIC PIN GRID ARRAY



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MO-128

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